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BigTwin SuperServer SYS-222BT-HER (Complete System Only @) **Coming Soon**

Datasheet 🕝 Share

2U 4-Node BigTwin with 8 hot-swap E3.S 1T NVMe drives per node



Key Applications

- All-Flash NVMe Hyperconverged Container-as-a-Service; Application Accelerator Infrastructure
- High-Performance File System Diskless HPC Clusters

Key Features

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 1. Dual Socket E2 Intel[®] Xeon[®] 6 6700 series processors with E-cores up to
- 205W with air cooling or 330W with liquid cooling
- 2. Up to 16 DIMMs supporting up to 4TB DDR5-6400 in 1DPC
- 3. Flexible networking with OCP 3.0 AIOM slot
- 4. Up to 2 PCIe 5.0 x16 LP slots
- Internal PCIe 5.0 for 2x NVMe M.2 support onboard
- Optional 4x NVMe M.2 support onboard with built-in HW RAID1 via SCC-A2NM2241GH-B1

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5. Up to 8 front hot-swap E3.S 1T PCIe 5.0 NVMe drive bays



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Parts List

Chassis

SuperServer SYS-222BT-HER

Motherboard

Processor (per Node)		Height	3.47" (88 mm)
CPU	Dual Socket E2 (LGA-4710) Intel [®] Xeon [®] 6700 series processors with E-cores	Width	17.68" (449 mm)
		Depth	28.75" (730 mm)
Core Count	Up to 144C/144T; Up to 108MB Cache per CPU	Package	9.76" (H) x 24.65" (W
Note	Supports up to 205W TDP CPUs (Air Cooled)* Supports up to 330W TDP CPUs (Liquid Cooled) *Air Cooled CPUs with TDP over 205W only supported under specific conditions. Contact a Supermicro representative for details.	Weight	Gross Weight: 96.6 lb Net Weight: 66.1 lbs
		Available Color	Black front & silver b
System Memory (per Node	e)	Front Panel	
Memory	Slot Count: 16 DIMM slots Max Memory (1DPC): Up to 2TB 6400MT/s ECC DDR5 RDIMM <u>View Memory Options</u> >	LED	HDD activity LED Network activity LED Power status LED Universal Informatio
On-Board Devices (per No	de)	Buttons	Dower On /Off buttor
Chipset	System on Chip	Buttons	Power On/Off buttor UID button
Network Connectivity	Via AIOM	Expansion Slots (per Node)
	<u>View AIOM Options</u> > <u>View AOC Options</u> >	PCI-Express (PCIe) Configuration	Default 2 PCIe 5.0 x16 LP
Input / Output (per Node)		1 PCIe 5.0 x1 <u>View AOC Optio</u>	
LAN	1 RJ45 1 GbE Dedicated BMC LAN port	Drive Bays / Storage (per N	lode)
USB	2 USB 3.0 Gen2 Type-A ports(Rear)		
Video	1 VGA port	Drive Bays Configuration	Default: Total 8 bays 8 front hot-swap
System BIOS		М.2	2 M.2 PCIe 5.0 x4 NVN required for RAID)
BIOS Type	AMI 32MB Flash ROM	System Cooling	
Management			

Form Factor 2U Rackmount

Model CSE-217BE3Q-R3K60P

<u>Super X14DBT-B</u>		Dimensions and Weight		
Processor (per Node)		Height	3.47" (88 mm)	
CPU	Dual Socket E2 (LGA-4710) Intel [®] Xeon [®] 6700 series processors with E-cores	Width	17.68" (449 mm)	
Core Count	Up to 144C/144T; Up to 108MB Cache per CPU	Depth	28.75" (730 mm)	
Note	Supports up to 205W TDP CPUs (Air Cooled)*	Package	9.76" (H) x 24.65" (W) x 45.28" (D)	
Note	Supports up to 330W TDP CPUs (Liquid Cooled) *Air Cooled CPUs with TDP over 205W only supported under specific conditions. Contact a Supermicro representative for	Weight	Gross Weight: 96.6 lbs (43.8 kg) Net Weight: 66.1 lbs (30 kg)	
	details.	Available Color	Black front & silver body	
System Memory (per Node	e)	Front Panel		
Memory	Slot Count: 16 DIMM slots Max Memory (1DPC): Up to 2TB 6400MT/s ECC DDR5 RDIMM <u>View Memory Options</u> >	LED	HDD activity LED Network activity LEDs Power status LED Universal Information (UID) LED	
On-Board Devices (per Node)		Buttons	Power On/Off button	
Chipset	System on Chip		UID button	
Network Connectivity	Via AIOM <u>View AIOM Options</u> >	Expansion Slots (per Node PCI-Express (PCIe)	Default 2 PCIe 5.0 x16 LP slots 1 PCIe 5.0 x16 AIOM slot (OCP 3.0 compatible) <u>View AOC Options</u> >	
Input / Output (per Node)	<u>View AOC Options</u> >	Configuration		
LAN	1 RJ45 1 GbE Dedicated BMC LAN port	Drive Bays / Storage (per N		
USB	2 USB 3.0 Gen2 Type-A ports(Rear)	Drive Bays / Storage (per h	Default: Total 8 bays	
Video	1 VGA port	Configuration	8 front hot-swap E3.S 1T PCIe 5.0 NVMe drive bays	
System BIOS		M.2	2 M.2 PCIe 5.0 x4 NVMe slots (M-key 22110(default); VROC required for RAID)	
BIOS Type	AMI 32MB Flash ROM	System Cooling		
Management		Fans	4x 16K RPM Counter Rotating 80x80x56mm Fan(s)	
Software	<u>SuperCloud Composer</u> <u>Supermicro Server Manager (SSM)</u> <u>Super Diagnostics Offline (SDO)</u> <u>Supermicro Thin-Agent Service (TAS)</u> <u>SuperServer Automation Assistant (SAA) New!</u>	Liquid Cooling	Direct to Chip (D2C) Cold Plate (optional)	
		Power Supply		
Power configurations	ACPI/APM Power Management	2x 3600W Redunda	2x 3600W Redundant (1 + 1) Titanium Level (96%) power supplies	
Security		Dimension (WxH	Dimension (WxHxL) 45 x 40 x 480 mm	
Hardware	Trusted Platform Module (TPM) 2.0 Silicon Root of Trust (RoT) – NIST 800-193 Compliant	In	Input 3600W: 0240Vdc / 50-60Hz (for CQC only) 1400W: 100-127Vac / 50-60Hz 3000W: 200-207.9Vac / 50-60Hz 3100W: 208-219.9Vac / 50-60Hz 3250W: 220-229.9Vac / 50-60Hz 3450W: 230-237.9Vac / 50-60Hz 3600W: 238-240Vac / 50-60Hz 3600W: 238-240Vac / 50-60Hz 3600W: 238-240Vac / 50-60Hz 3600W: 238-240Vac / 50-60Hz	
Features	Cryptographically Signed Firmware Secure Boot Secure Firmware Updates Automatic Firmware Recovery Supply Chain Security: Remote Attestation Runtime BMC Protections System Lockdown	+		
PC Health Monitoring			Max: 240A / Min: 0A (200Vac-207.9Vac) Max: 248A / Min: 0A (208Vac-219.9Vac) Max: 260A / Min: 0A (220Vac-229.9Vac) Max: 276A / Min: 0A (230Vac-237.9Vac) Max: 288A / Min: 0A (238Vac-240Vac)	
FAN	Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors			
Temperature	Monitoring for CPU and chassis environment	12	/ SB Max: 4.5A / Min: 0A	
CPU	Monitors for CPU Cores, Chipset Voltages, Memory. 8+4 Phase-switching voltage regulator	Output T	Output Type Backplanes (gold finger)	
		Operating Environment		
		ROHS RoHS Compliant		
		Environmental Spec.	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -30°C to 60°C (-22°F to 140°F) Operating Relative Humidity: 8% to 80% (non-condensing) Non-operating Relative Humidity: 8% to 90% (non-condensing)	

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